

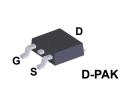
# ON Semiconductor® FQD4P40 P-Channel QFET® MOSFET -400 V, -2.7 A, 3.1 Ω

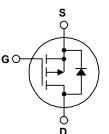
# Description

These P-Channel enhancement mode power field effect transistors are produced using ON Semiconductor's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for electronic lamp ballast based on complimentary half bridge.

### Features

- 2.7 A, -400 V,  $R_{DS(on)}$  = 3.1  $\Omega$  (Max.) @ V\_{GS} = -10 V,  $I_{D}$  = -1.35 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 11 pF)
- 100% Avalanche Tested





### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted.

Symbol	Parameter	FQD4P40TM	Unit	
V <sub>DSS</sub>	Drain-Source Voltage	-400	V	
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25	-2.7	А	
	- Continuous (T <sub>C</sub> = 10	-1.71	A	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	-10.8	Α
V <sub>GSS</sub>	Gate-Source Voltage	$\pm 30$	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	260	mJ A mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	-2.7	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	5.0	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = 25°C) *	2.5	W	
	Power Dissipation ( $T_C = 25^{\circ}C$ )	50	W	
	- Derate above 25°C	0.4	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering 1/8" from case for 5 seconds	300	°C	

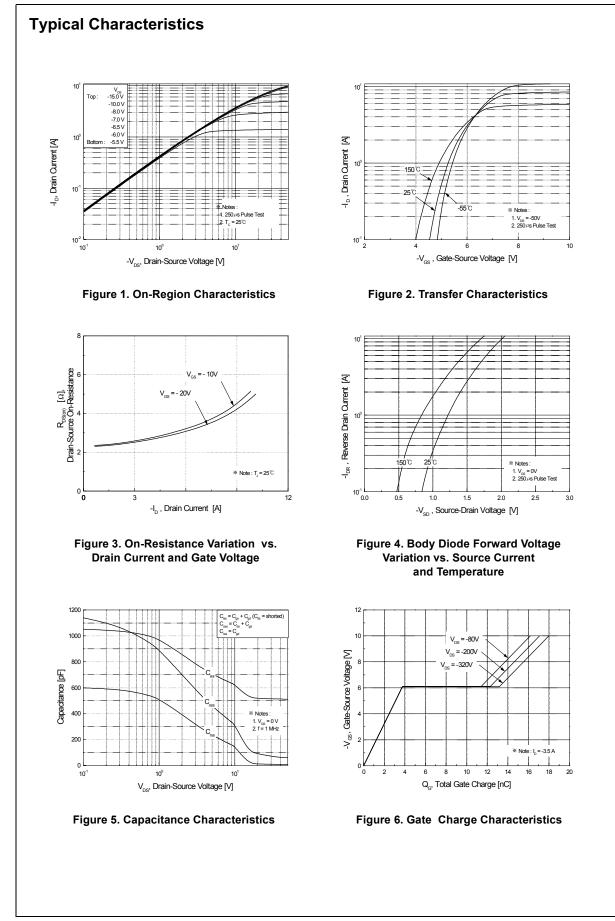
## **Thermal Characteristics**

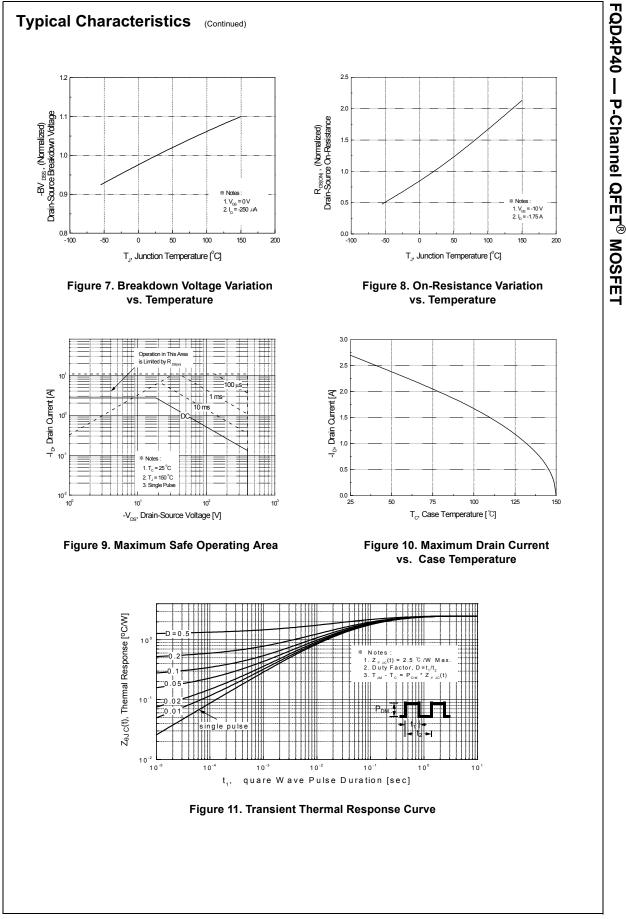
Symbol	Parameter	FQD4P40TM	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.5	
Р	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

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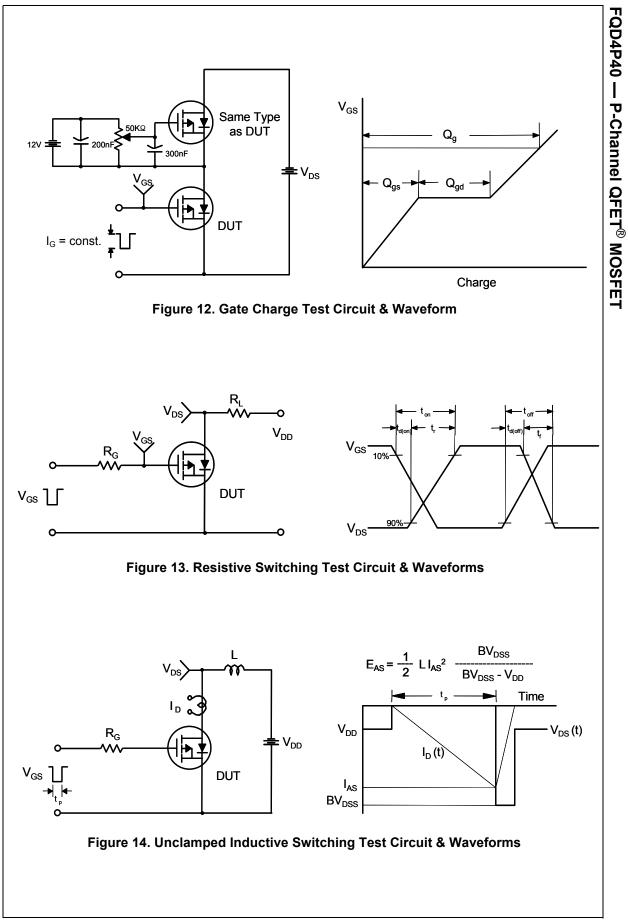
Part Nu FQD4P4		-		kagePacking MethodReelPAKTape and Reel330			Tape Width 16 mm		Quantity 2500 units	
ectri	cal Ch	aracteristics	T <sub>c</sub> = 25°C un	less otherv	vise noted.					
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit
	ractori	etice								
BV <sub>DSS</sub>	aracteristics Drain-Source Breakdown Voltage		V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA			-400			V	
ABV <sub>DSS</sub>	Breakdown Voltage Temperature				-400			v		
$\Delta T_{\rm J}$	Coefficient		$I_D$ = -250 $\mu$ A, Referenced to 25°C			0.36		V/°C		
I <sub>DSS</sub>	Zero Gate Voltage Drain Current		V <sub>DS</sub> = -400 V, V <sub>GS</sub> = 0 V				-1	μA		
			$V_{DS} = -320 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$				-10	μA		
GSSF	Gate-Body Leakage Current, Forward		V <sub>GS</sub> = -30 V, V <sub>DS</sub> = 0 V					-100	nA	
GSSR	Gate-Body Leakage Current, Reverse			V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V					100	nA
							1	L	1	
Jn Cna V <sub>GS(th)</sub>	racteristics Gate Threshold Voltage		V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA			-3.0		-5.0	V	
R <sub>DS(on)</sub>		rain-Source		-			0.0			
DO(01)	On-Res				-10 V, I <sub>D</sub> = -1.35 A			2.44	3.1	Ω
9 <sub>FS</sub>	Forward	Transconductance		V <sub>DS</sub> =	-50 V, I <sub>D</sub> = -1.35 A			2.5		S
Nynami	ic Char	acteristics								
C <sub>iss</sub>	1	apacitance			-25 V, V <sub>GS</sub> = 0 V,			520	680	pF
C <sub>oss</sub>	Output (	Capacitance		f = 1.0				80	105	pF
C <sub>rss</sub>		Reverse Transfer Capacitance					11	15	pF	
	na Cha	raatariatiaa					1	I.	1	
d(on)		Delay Time						13	35	ns
r		n Rise Time			-200 V, I <sub>D</sub> = -3.5 A,			55	120	ns
d(off)		f Delay Time		R <sub>G</sub> = 2	25 Ω			35	80	ns
f		f Fall Time		-		(Note 4)		37	85	ns
, ל <sup>מ</sup>		ate Charge		V -	-320 V, I <sub>D</sub> = -3.5 A,			18	23	nC
Q <sub>gs</sub>		ource Charge		V <sub>DS</sub> =	5			3.8		nC
Q <sub>gd</sub>		rain Charge		*GS	10 0	(Note 4)		9.4		nC
	I									
		Diode Character							07	
S		m Pulsed Drain-Sour							-2.7	A
sм V <sub>SD</sub>		ource Diode Forward			0 V, I <sub>S</sub> = -2.7 A				-10.8 -5.0	A
vsD ∳rr		e Recovery Time	vollage		$0 \text{ V}, \text{ I}_{\text{S}} = -3.5 \text{ A},$			260	-5.0	ns
nr Q <sub>rr</sub>		e Recovery Charge		00	t = 100 A/μs			1.4		μC
lotes: . Repetitive . L = 62 mH, . I <sub>SD</sub> ≤ -3.5 A	rating: pulse- I <sub>AS</sub> = -2.7 A, , di/dt ≤ 200	width limited by maximum ju $V_{DD} = -50 V$ , $R_G = 25 \Omega$ , stating $A/\mu$ s, $V_{DD} \le BV_{DSs}$ , starting t of operating temperature.	rting $T_J = 25^\circ$	rature.			<u></u>			

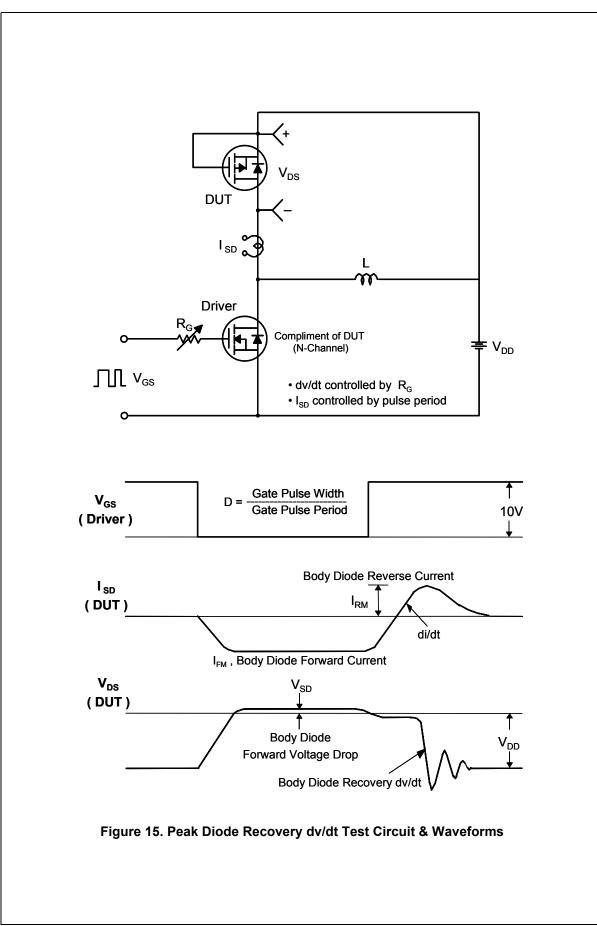
FQD4P40 — P-Channel QFET<sup>®</sup> MOSFET

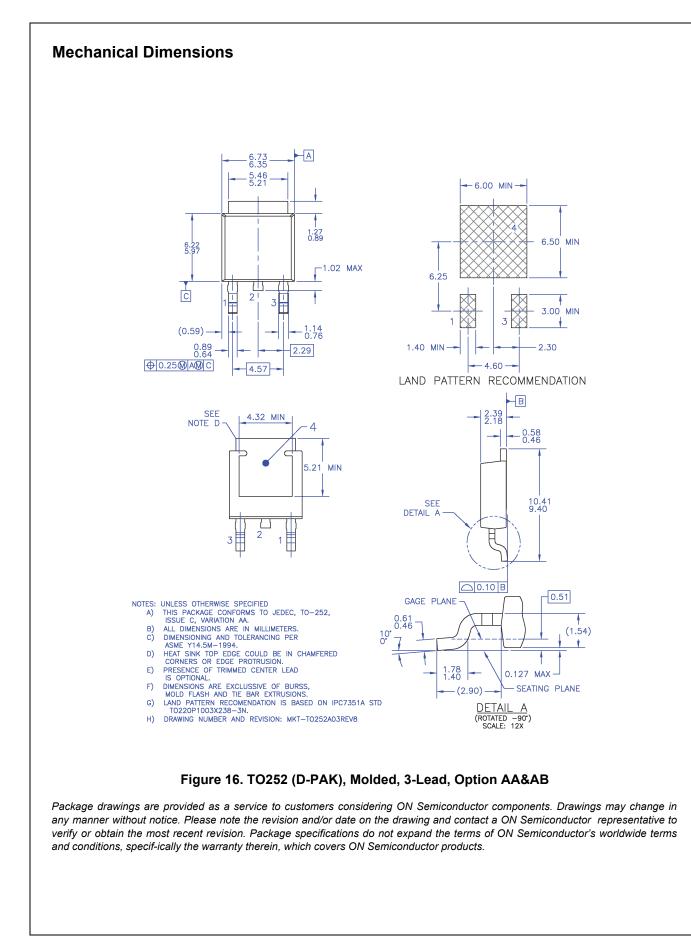




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